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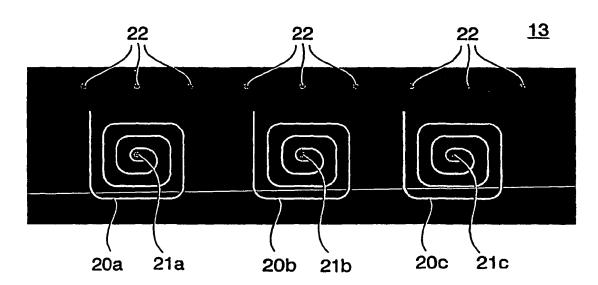
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(54) Title: DEVICE COMPRISING A CIRCUIT ARRANGEMENT WITH AN INDUCTIVE ELEMENT



(57) Abstract: The invention relates to a device which comprises a circuit arrangement and at least one inductive element. In order to form a device with a circuit arrangement with one or more inductive elements which can be manufactured as economically as possible, it is proposed to use an electrically conductive plate (13) having an inductive function, the inductive function corresponding to a structure of slits (20a,20b,20c) formed in the plate.

